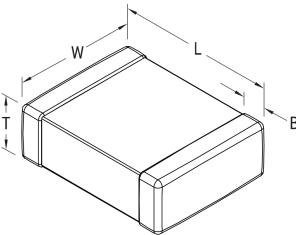


CBR06C829B5GAC

CBR-SMD RF COG, Ceramic, 8.2 pF, +/-0.1 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
Т	0.8mm +/-0.07mm
В	0.4mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

CBR-SMD RF COG
SMD Chip
SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Ultra High Q, Low ESR, Class I
Yes
Tin
No
No
5.29 mg
Solder Wave or Solder Reflow.
78 Weeks
1

Specifications	
Capacitance	8.2 pF
Capacitance Tolerance	+/-0.1 pF
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Dissipation Factor	0.177%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	564

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